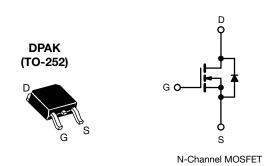
COMPLIANT

HALOGEN

FREE



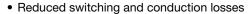
E Series Power MOSFET



PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	650)	
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.269		
Q _g max. (nC)	64		
Q _{gs} (nC)	8		
Q _{gd} (nC)	13		
Configuration	Sing	le	

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
	SiHD14N60E-GE3
Load (Dh) fuse and helegen fuse	SiHD14N60ET1-GE3
Lead (Pb)-free and halogen-free	SiHD14N60ET4-GE3
	SiHD14N60ET5-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	V
Continuous dusin suggest (T. 150 °C)	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$,	13	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	8	Α
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				1.2	W/°C
Single pulse avalanche energy b			E _{AS}	136	mJ
Maximum power dissipation			P_{D}	147	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		-11//-14	70	\//
Reverse diode dV/dt ^d	•		dV/dt	32	- V/ns
Soldering recommendations (peak temperature) ^c	for	10 s		300	°C

- a. Repetitive rating; pulse width limited by maximum junction temperature b. $V_{DD}=140$ V, starting $T_J=25$ °C, L=28.2 mH, $R_g=25~\Omega,~I_{AS}=3.1$ A c. 1.6 mm from case d. $I_{SD}\leq I_D,~dI/dt=100~A/\mu s,$ starting $T_J=25~^\circ C$



Vishay Siliconix

THERMAL RESISTANCE RATI	RMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.85	G/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Onto anima lankana			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava gata valtaga dyain avyyant		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7 A	-	0.269	0.309	Ω
Forward transconductance	9 _{fs}	V _{DS}	_s = 30 V, I _D = 7 A	-	3.8	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	1205	-	pF
Output capacitance	C _{oss}	7	$V_{GS} = 0 V$, $V_{DS} = 100 V$,		62	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		_	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	52	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	177	-	
Total gate charge	Qg			-	32	64	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 7 A, V_{DS} = 480 V$	-	8	-	nC
Gate-drain charge	Q _{gd}			-	13	-	
Turn-on delay time	t _{d(on)}			-	15	30	
Rise time	t _r	V _{DD} = 480 V, I _D = 7 A,		38	7		
Turn-off delay time	t _{d(off)}	V _{GS} :	$V_{DD} = 400 \text{ V}, I_D = 7 \text{ A},$ $V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		35	70	ns
Fall time	t _f				15	30	1
Gate input resistance	R_g	f = 1 MHz, open drain		0.38	0.75	1.5	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	13	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	32	- A
Diode forward voltage	V _{SD}	T _J = 25 °	C, I _S = 7 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	281	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 7 \text{ A},$ $dI/dt = 100 \text{ A/µs}, V_R = 25 \text{ V}$		-	3.4	-	μC
Reverse recovery current	I _{RRM}			_	22	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

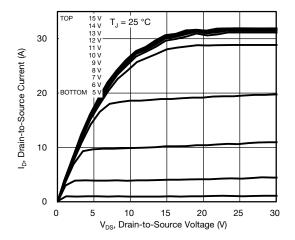


Fig. 1 - Typical Output Characteristics

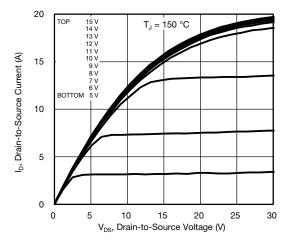


Fig. 2 - Typical Output Characteristics

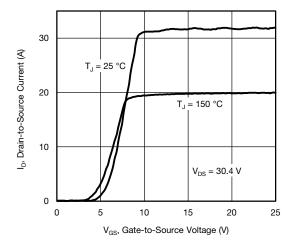


Fig. 3 - Typical Transfer Characteristics

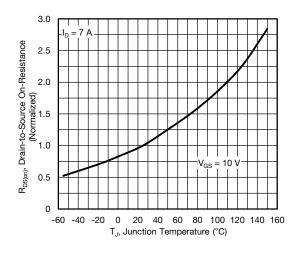


Fig. 4 - Normalized On-Resistance vs. Temperature

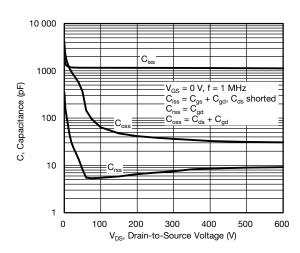


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

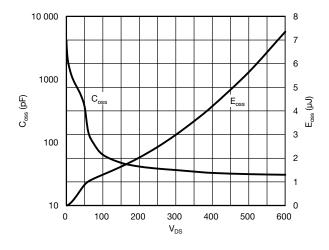


Fig. 6 - Coss and Eoss vs. VDS



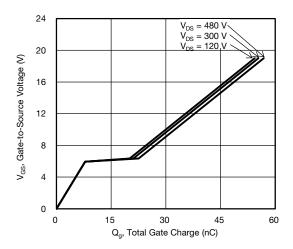


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

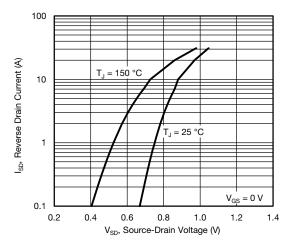


Fig. 8 - Typical Source-Drain Diode Forward Voltage

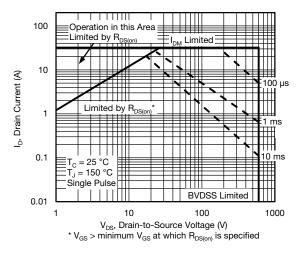


Fig. 9 - Maximum Safe Operating Area

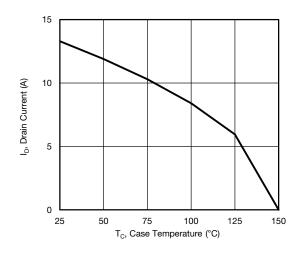


Fig. 10 - Maximum Drain Current vs. Case Temperature

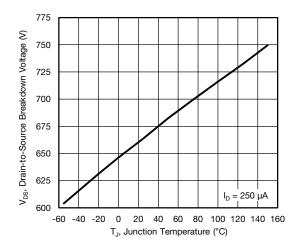


Fig. 11 - Temperature vs. Drain-to-Source Voltage



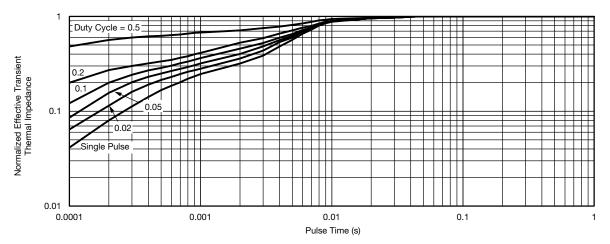


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

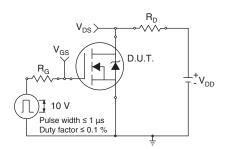


Fig. 13 - Switching Time Test Circuit

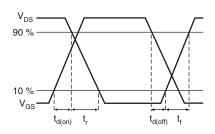


Fig. 14 - Switching Time Waveforms

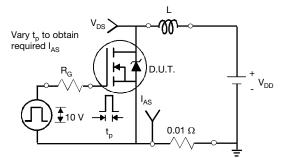


Fig. 15 - Unclamped Inductive Test Circuit

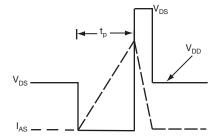


Fig. 16 - Unclamped Inductive Waveforms

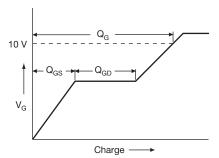


Fig. 17 - Basic Gate Charge Waveform

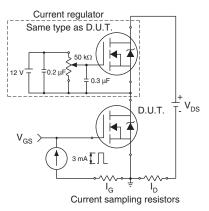
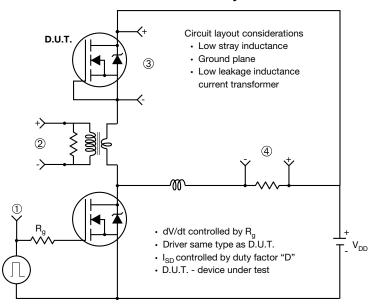


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



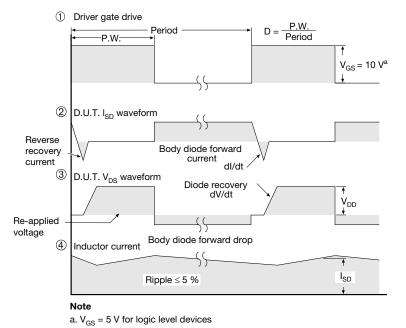
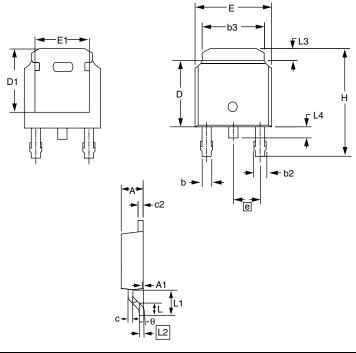


Fig. 19 - For N-Channel

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TO-252AA (HIGH VOLTAGE)



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Е	6.40	6.73	0.252	0.265	
L,	1.40	1.77	0.055	0.070	
L1	2.743 REF		0.108 REF		
L2	0.508	BBSC	0.020) BSC	
L3	0.89	1.27	0.035	0.050	
L4	0.64	1.01	0.025	0.040	
D	6.00	6.22	0.236	0.245	
Н	9.40	10.40	0.370	0.409	
b	0.64	0.88	0.025	0.035	
b2	0.77	1.14	0.030	0.045	
b3	5.21	5.46	0.205	0.215	
е	2.286	2.286 BSC		0.090 BSC	
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
С	0.45	0.60	0.018	0.024	
c2	0.45	0.58	0.018	0.023	
D1	5.30	-	0.209	-	
E1	4.40	-	0.173	-	
θ	0'	10'	0'	10'	

ECN: S-81965-Rev. A, 15-Sep-08

DWG: 5973

Notes

- 1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.
- 2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.
- 3. The package top may be smaller than the package bottom.
- 4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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